



Product Change Notification

Change Notification #: 118957-00
Change Title: Intel® FPGA PAC N3000, PAC D5005 & PAC with Intel® Arria® 10 GX FPGA acceleration cards,
PCN 118957-00, Product Discontinuance,
End of Life
Date of Publication: March 15, 2022

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Device Family	Last Order Date ⁽¹⁾	Last Time Shipments ⁽²⁾
Intel® FPGA PAC N3000, PAC D5005 & PAC with Intel® Arria® 10 GX FPGA acceleration cards	July 11, 2022	March 10, 2023

(1) Orders will become non-cancelable, non-reschedulable, non-returnable on the Last Order Date.

(2) Order fulfillment is not guaranteed and subject to global supply availability.

Description of Change to the Customer:

This is the same product discontinuance notice described in PDN2211 issued on March 11, 2022.

Due to product transition and declining demand, Intel is discontinuing Intel® FPGA PAC N3000, PAC D5005 & PAC with Intel® Arria® 10 GX FPGA acceleration cards.

Customer Impact of Change and Recommended Action:

While there is no direct drop in replacement acceleration cards available, Intel recommends that customers migrate to an alternate acceleration card as appropriate.

Customers may place last-time-buy orders on the ordering part numbers (OPNs) impacted by this discontinuance notice. Given the unprecedented global demand for, and limited supply of semiconductor components and substrates, Intel does not guarantee fulfillment of last-time-buy orders

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	Affected MM#	Recommended Replacement Product Code	Recommended Replacement MM#
Intel® PAC With Arria® 10 GX FPGA DK-ACB-10AX1152AES	DK-ACB-10AX1152AES	980017	N/A	N/A
Intel® PAC With Arria® 10 GX FPGA BD-ACD-10AX1152H	BD-ACD-10AX1152H	983136	N/A	N/A
Intel® PAC With Arria® 10 GX FPGA BD-ACD-10AX1152D	BD-ACD-10AX1152D	983173	N/A	N/A
Intel® PAC With Arria® 10 GX FPGA BD-ACD-10AX1152B	BD-ACD-10AX1152B	999A65	N/A	N/A
Intel® FPGA PAC D5005 BD-ACD-1SX280H2DES	BD-ACD-1SX280H2DES	999AG0	N/A	N/A
Intel® FPGA PAC D5005 BD-ACD-D5005-1	BD-ACD-D5005-1	999DHT	N/A	N/A
Intel® FPGA PAC N3000 BD-NVV-N3000-1	BD-NVV-N3000-1	999DXF	N/A	N/A
Intel® FPGA PAC N3000 BD-NFV-N3000-1	BD-NFV-N3000-1	999H1K	N/A	N/A
Intel® FPGA PAC N3000 BD-NVV-N3000-2	BD-NVV-N3000-2	999HGN	N/A	N/A
Intel® FPGA PAC N3000 BD-NVV-N3000-3	BD-NVV-N3000-3	999PJD	N/A	N/A
Intel® FPGA PAC N3000 BD-NVV-N3000-V	BD-NVV-N3000-V	999WCF	N/A	N/A
Intel® FPGA PAC N3000 BD-NVV-N3000-3ES	BD-NVV-N3000-3ES	99A18V	N/A	N/A
Intel® FPGA PAC N3000 BD-NVV-N3000-VH	BD-NVV-N3000-VH	99A2HD	N/A	N/A
Intel® FPGA PAC N3000 BD-NVV-N3000-3DL	BD-NVV-N3000-3DL	99A392	N/A	N/A
Intel® FPGA PAC D5005 BD-ACD-D5005-1U	BD-ACD-D5005-1U	99AHNP	N/A	N/A

PCN Revision History:**Date of Revision:**

March 15, 2022

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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